



#### COMPLEMENTARY 60V ENHANCEMENT MODE MOSFET H-BRIDGE

#### **Product Summary**

Device	BV <sub>DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C	
N. Observat	001/	0.3Ω @ V <sub>GS</sub> = 10V	1.8A	
N-Channel	60V	0.45Ω @ V <sub>GS</sub> = 4.5V	1.4A	
D. Ohaanaal	001/	0.425Ω @ V <sub>GS</sub> = -10V	-1.5A	
P-Channel	-60V	0.63Ω @ V <sub>GS</sub> = -4.5V	-1.2A	

### **Description**

This new generation complementary MOSFET H-Bridge features low on-resistance achievable with low gate drive.

#### **Applications**

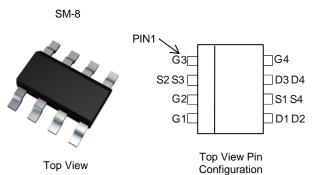
- DC Motor Control
- DC-AC Inverters

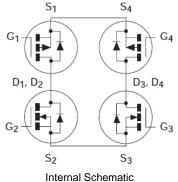
#### **Features**

- 2 x N + 2 x P Channels in a SOIC Package
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: SM-8 (8 LEAD SOT223)
- Case Material: Molded Plastic, "Green" Molding Compound;
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.117 grams (Approximate)





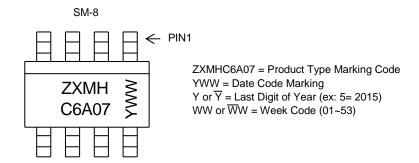
#### **Ordering Information** (Note 4)

Part Number	Reel Size	Tape Width	Quantity Per Reel
ZXMHC6A07T8TA	7"	12mm	1,000 units
ZXMHC6A07T8TC	13"	12mm	4,000 units

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

#### **Marking Information**





# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	N-channel	P-channel	Units		
Drain-Source Voltage		$V_{DSS}$	60	-60	V	
Gate-Source Voltage			V <sub>GSS</sub>	±20	±20	V
Continuous Drain Current, $V_{GS} = 10V$ (Note 8) Steady State $T_A = +25^{\circ}C$ (Note 6) $T_A = +70^{\circ}C$ (Note 6) $T_A = +25^{\circ}C$ (Note 5)				1.8 1.4 1.6	-1.5 -1.2 -1.3	Α
Maximum Body Diode Forward Current (Note 6)	Is	2.3	-2.1	Α		
Pulsed Drain Current (Note 7)	$I_{DM}$	8.4	-7.2	Α		
Pulsed Source Current (Note 7)	I <sub>SM</sub>	8.4	-7.2	А		

## Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

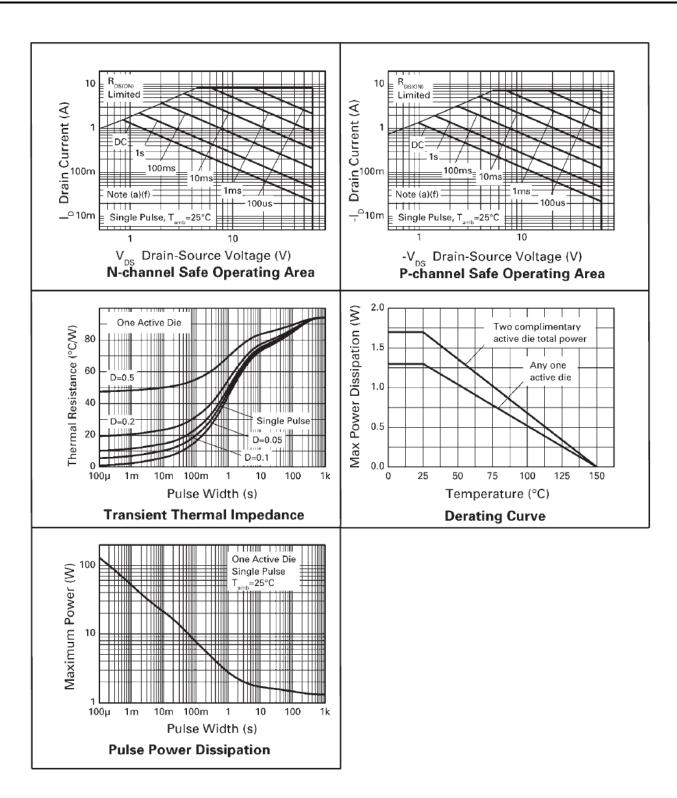
Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 8) Linear Derating Factor	T <sub>A</sub> = +25°C (Note 5)	$P_D$	1.3 10.4	W mW/°C
Total Power Dissipation (Note 8) Linear Derating Factor	T <sub>A</sub> = +25°C (Note 6)	P <sub>D</sub>	1.7 13.6	W mW/°C
Thermal Resistance, Junction to Ambient (Note 8)	Steady State (Note 5)	-	94.5	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State (Note 6)	R <sub>θJA</sub>	73.3	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C	

- 5. For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions, with the heat sink split into two equal areas one for each drain connection.
- 6. For a device surface mounted on FR4 PCB measured at t ≤10 seconds.
- 7. Repetitive rating 50mm x 50mm x 1.6mm FR4 PCB, D = 0.02, pulse width 300µs pulse width limited by maximum junction temperature. Refer to Transient Thermal Impedance graph.

  8. For device with one active die.



# **Typical Characteristics**





# Electrical Characteristics N-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 10)								
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	1	_	V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		_	1.0	μΑ	$V_{DS} = 60V, V_{GS} = 0V$		
Gate-Source Leakage	I <sub>GSS</sub>	_	_	100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 10)								
Gate Threshold Voltage	V <sub>GS(th)</sub>	1.0	-	3.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$		
Static Drain-Source On-Resistance (Note 9)		1		0.3	Ω	$V_{GS} = 10V, I_D = 1.8A$		
Static Drain-Source On-Resistance (Note 9)	R <sub>DS</sub> (ON)	1	_	0.45	22	$V_{GS} = 4.5V, I_D = 1.3A$		
Forward Transfer Admittance (Notes 9 & 11)	g <sub>fs</sub>	1	2.3	_	S	$V_{DS} = 15V, I_D = 1.8A$		
Diode Forward Voltage (Note 9)	$V_{SD}$		0.85	0.95	V	$T_J = +25$ °C, $V_{GS} = 0V$ , $I_S = 0.45$ A		
DYNAMIC CHARACTERISTICS (Note 11)								
Input Capacitance	C <sub>iss</sub>	I	166	_		10)/ )/		
Output Capacitance	Coss	I	19.5		pF	$V_{DS} = 40V$ , $V_{GS} = 0V$ , $f = 1MHz$		
Reverse Transfer Capacitance	Crss	I	8.7	_		1 – 1101112		
Gate Charge (V <sub>GS</sub> = -5.0V)	$Q_g$		1.65	_	nC			
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg	_	3.2	_		\/ 20\/ I 4.0A		
Gate-Source Charge	$Q_{gs}$	_	0.67	_	nC	$V_{DS} = 30V, I_{D} = 1.8A$		
Gate-Drain Charge	$Q_{gd}$	_	0.82	_				
Turn-On Delay Time	t <sub>D(on)</sub>	_	1.8	_				
Turn-On Rise Time	t <sub>r</sub>	_	1.4	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_{D} = 1.8A, R_{G} = 6.0\Omega$		
Turn-Off Delay Time	t <sub>D(off)</sub>	_	4.9	_	ns			
Turn-Off Fall Time	t <sub>f</sub>	_	2.0	_				
Reverse Recovery Time	t <sub>rr</sub>	_	20.5	_	ns	$T_J = +25^{\circ}C$ , $I_S = 1.8A$ ,		
Reverse Recovery Charge	Qrr	1	21.3	_	nC	di/dt = 100A/µs		

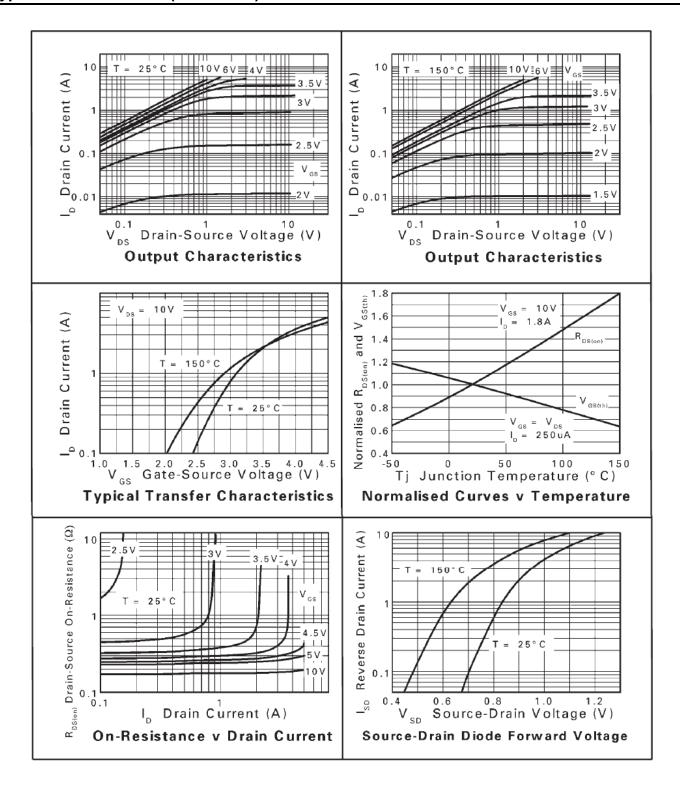
## Electrical Characteristics P-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
DFF CHARACTERISTICS (Note 10)								
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-60	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	-1.0	μA	$V_{DS} = -60V, V_{GS} = 0V$		
Gate-Source Leakage	I <sub>GSS</sub>	_	_	100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 10)	0 000							
Gate Threshold Voltage	$V_{GS(th)}$	-1.0	_	_	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		
Statio Prain Source On Registance (Note 0)		_	_	0.425	Ω	$V_{GS} = -10V, I_D = -0.9A$		
Static Drain-Source On-Resistance (Note 9)	R <sub>DS</sub> (ON)	_	_	0.63	12	$V_{GS} = -4.5V, I_D = -0.8A$		
Forward Transfer Admittance (Notes 9 & 11)	<b>g</b> fs	_	1.8	_	S	V <sub>DS</sub> = -15V, I <sub>D</sub> = -0.9A		
Diode Forward Voltage (Note 9)	V <sub>SD</sub>	_	-0.85	-0.95	٧	$T_J = +25^{\circ}\text{C}, V_{GS} = 0\text{V},$ $I_S = -0.8\text{A}$		
DYNAMIC CHARACTERISTICS (Note 11)			l.			, 9		
Input Capacitance	C <sub>iss</sub>	_	233	_	pF			
Output Capacitance	Coss	_	17.4	_	pF	V <sub>DS</sub> = -30V, V <sub>GS</sub> = 0V, f = 1MHz		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	9.6	_	pF	1 = 11VID2		
Gate Charge (V <sub>GS</sub> = -5.0V)	Qq	_	2.4	_	nC			
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg	_	5.1	_	nC	],, , , , , , , , , , , , , , , , , , ,		
Gate-Source Charge	Q <sub>gs</sub>	_	0.7	_	nC	$V_{DS} = -30V, I_{D} = -0.9A,$		
Gate-Drain Charge	$Q_{qd}$	_	0.7	_	nC			
Turn-On Delay Time	t <sub>D(on)</sub>	_	1.6	_	ns			
Turn-On Rise Time	t <sub>r</sub>		2.3		ns	$V_{DD} = -30V, V_{GS} = -10V,$		
Turn-Off Delay Time	t <sub>D(off)</sub>		13	_	ns	$R_G = 6.0\Omega$ , $I_D = -1.0A$		
Turn-Off Fall Time	t <sub>f</sub>		5.8	_	ns	1		
Reverse Recovery Time	t <sub>rr</sub>	_	22.6	_	ns	T 0500 I 0.04 II/II 10011		
Reverse Recovery Charge	$Q_{rr}$		23.2	_	nC	$T_J = +25$ °C, $I_S = -0.9$ A, $di/dt = 100$ A/ $\mu$ s		

- 9. Measured under pulsed conditions. Width≤300 $\mu$ s. Duty cycle ≤ 2%.
- Measured under pulsed conditions. Wildingsoops. Buty cycle is
   Short duration pulse test used to minimize self-heating effect.
   Guaranteed by design. Not subject to product testing.

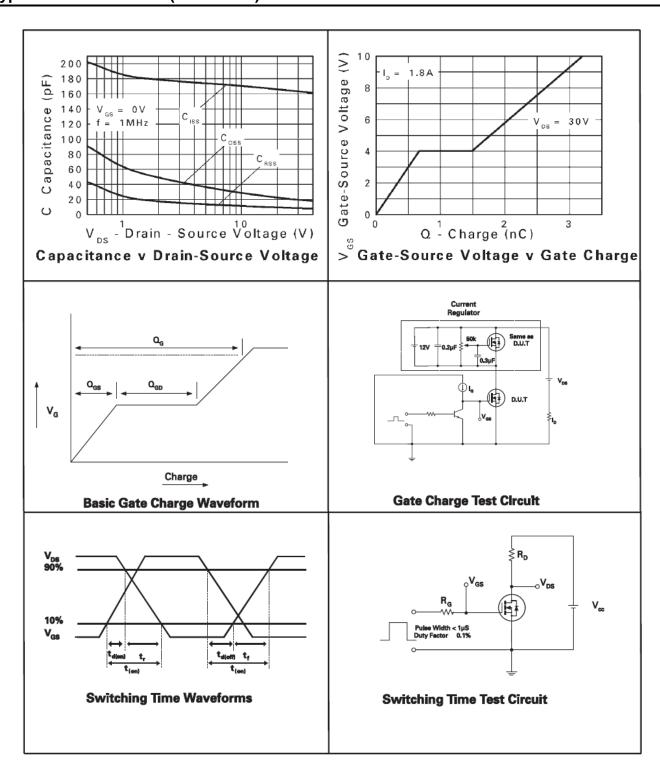


## **Typical Characteristics (N-Channel)**



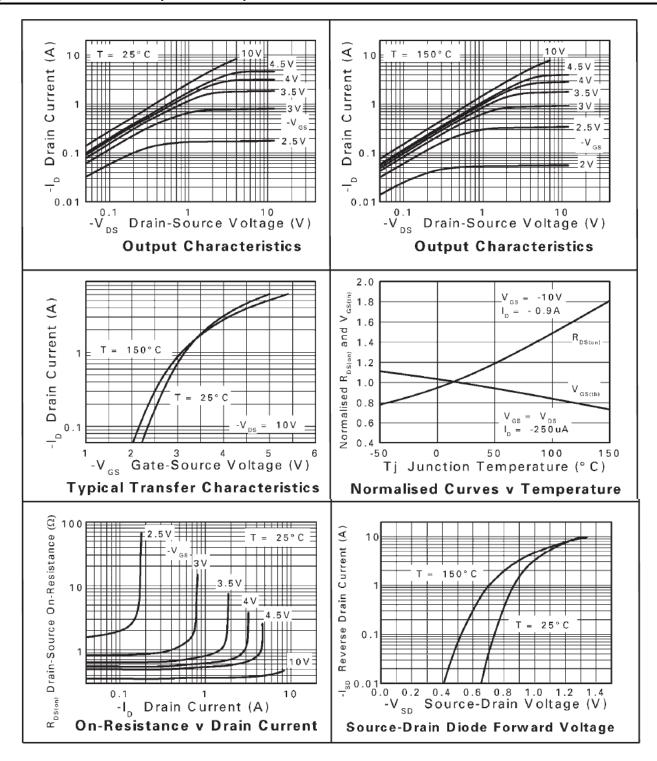


# **Typical Characteristics (N-Channel)**



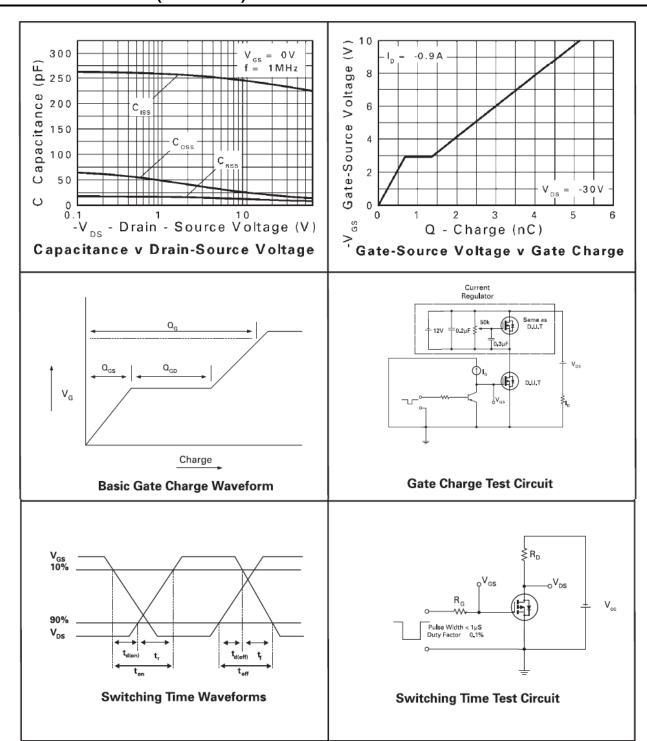


# **Typical Characteristics (P-Channel)**





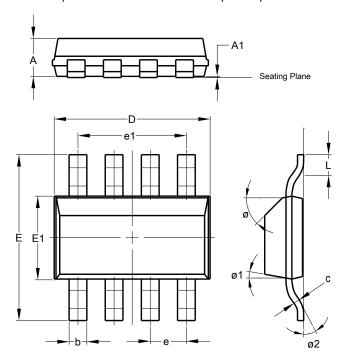
# **Typical Characteristics (P-Channel)**





#### **Package Outline Dimensions**

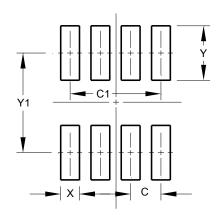
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SM-8							
Dim	Min Max Typ						
Α		1.70	1.60				
A1	0.02	0.10	0.04				
b	0.70	0.90	0.80				
С	0.24	0.32	0.28				
D	6.30	6.30 6.70 6.60					
е	1.53 REF						
e1	4.59 REF						
Е	6.70 7.30 7.00						
E1	3.30 3.70 3.50						
L	0.75 1.00 0.90						
Ø	45°						
Ø1	15°						
Ø2			10°				
All Dimensions in mm							

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.52
C1	4.60
Х	0.95
Y	2.80
Y1	6.80



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